

SYM	ECN	DESCRIPTION	DATE	APPROVED

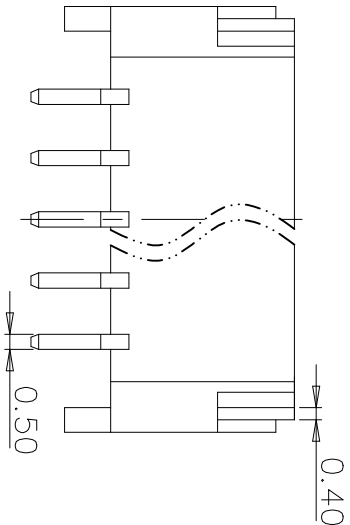
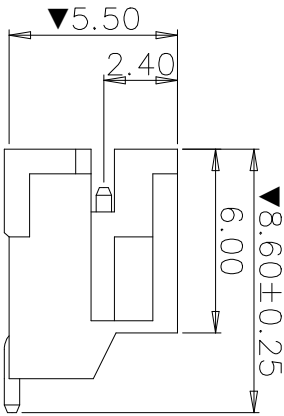
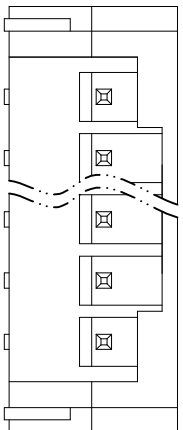
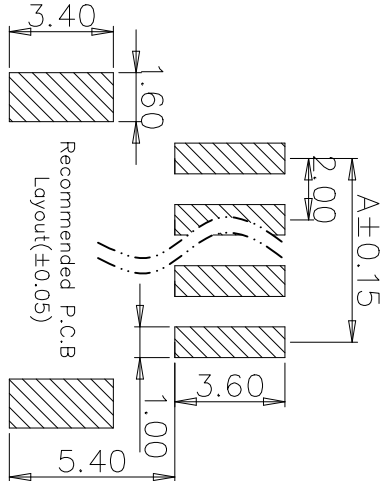
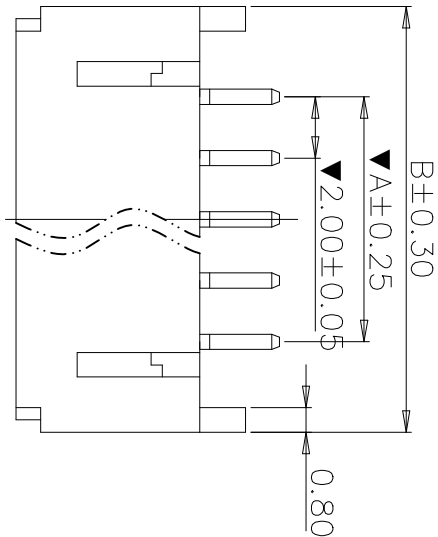


Technical Data

Material:
Contact material:brass
Contact plating:see ordering information
Solder tab:brass,tin plated over nickel plated
Insulator material:Thermoplastic,UL94V-2

Electrical:
Current rating:2A AC/DC
Contact resistance: $\leq 20\text{m}\Omega$ /contact
Insulation resistance: $\geq 1000\text{M}\Omega$
Voltage rating:250V AC/DC
Withstanding voltage:800V AC/minute

Mechanical:
Temperatures range: -25°C to $+85^{\circ}\text{C}$
Soldering temperature: $260^{\circ}\text{C}\pm 5^{\circ}$ 5S
Critical Dimensions:▼



Dim No.	A	B	Dim No.	A	B
2	2.00	7.90	10	18.00	23.90
3	4.00	9.90	11	20.00	25.90
4	6.00	11.90	12	22.00	27.90
5	8.00	13.90	13	24.00	29.90
6	10.00	15.90	14	26.00	31.90
7	12.00	17.90	15	28.00	33.90
8	14.00	19.90	16	30.00	35.90
9	16.00	21.90	—		

Ordering information

WFD1XX – B XX T 01 X

No. of Pins Contact Plating Color
02-16 01=Tin A=Black
 02=Gold Flash B=Beige
 D=White

Packing		natconn® 广东纳特康电子股份有限公司 GUANGDONG NATCONN ELECTRONIC CO.,LTD					
1.General							
2.Tape&Reel		TOLERANCE: ANGLE $\pm 2^{\circ}$ PROJECTION: TITLE: Pitch2.0mm wafer horizontal SMT type DATE: 2015/09/02 CUSTOMER: 雷邦军 DRAWN: 唐建平 CHECKED: 冯显东 APPROVED: 冯显东 CUSTOMER P/N: N/A PART NO.: WFD1XX-B01T01X DRAWING NO.: WFD1XX-B01T01X SIZE: A4 UNIT: mm SCALE: 1:1 SHEET: 1/1					
3.Tube	√						
4.Tray							
5.Other							